IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information			
upplier Infor	mation														
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
nsemi											2025-05-12				
Contact Name		Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-Env-Stev	wards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Repres	sentative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stev	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reques	Requester Item Number Mfr Iter		em Number Mfr Item Name				Effective Dat	e Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP51530AMNTWG 700V Half Bridge Dri		Driver		2025-05-12			PH1		26.57	mg	Each		
	g Proccess Information	on						İ					·		
Terminal Plating / Grid Array Material			Ferminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature		re Max Time at Peal	k Tempera	ture Numb	per of Reflow Cyc	eles			
Matte Tin (Sn) - annealed			CU Alloy 1			260 C		30	secoi	nds 3					
omments															
vel 1 - maximum	ı time at peak temperatur	e during sol	dering is 10-3	0 seconds											
or more informa	tion regarding material co	omposition 1	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.24	mg	Supplier	Silicon (Si)	7440-21-3		1.24	mg
Die Attach Tape	0.07	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0105	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2-methyl-2-propenoate	25035-69-2		0.0105	mg
			Supplier	Proprietary	Proprietary Data		0.007	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0315	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0105	mg
Lead Frame	11.66	mg	Supplier	Silver (Ag)	7440-22-4		0.1166	mg
			Supplier	Tin (Sn)	7440-31-5		0.0291	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0257	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0291	mg
			Supplier	Copper (Cu)	7440-50-8		11.4594	mg
Mold Compound-Black	12.96	mg		Epoxy resin	proprietary data		0.648	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2981	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.648	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0518	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2981	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.016	mg
Plating	0.47	mg	Supplier	Tin (Sn)	7440-31-5		0.47	mg
Wire Bond - Au	0.17	mg	Supplier	Gold (Au)	7440-57-5		0.17	mg